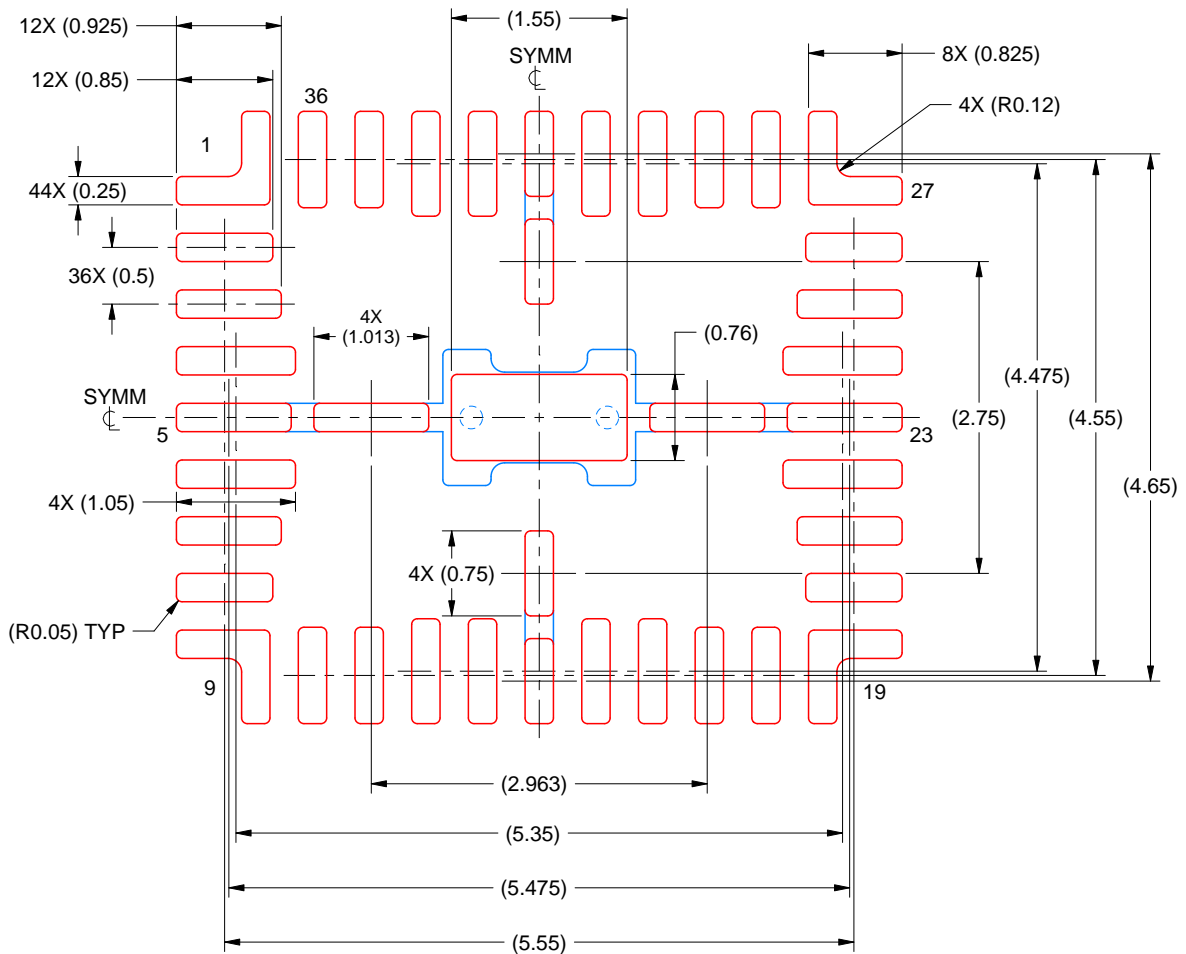


EXAMPLE STENCIL DESIGN

RAH0036A

VQFN-HR - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
 BASED ON 0.125 MM THICK STENCIL
 SCALE: 15X

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
 PAD CONNECTED TO PINS 5 & 23: 76%
 PADS 14 & 32: 88%

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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